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2 SHEET

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09/785750  
02/20/01

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Atty Docket #:  
ONS00173

101663574

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying part(ies):  
Frantisek Mikulenka  
  
2/20/01

2. Name and address of receiving party(ies):  
  
Name: Semiconductor Components Industries, LLC  
  
Internal Address: Patent Administration Dept. - A230

3. Nature of conveyance:  
 Assignment       Merger  
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Execution date of conveyance: January 31, 2001

Additional name(s) & address(es) attached?       Yes       No

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is: February 15, 2001

A. Patent Application No.(s):

B. Patent No.(s): 09 785 750

Additional numbers attached?       Yes       No

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: Semiconductor Components Industries, LLC  
Internal Address: Patent Administration Dept - MD A230  
Street Address: P.O. Box 62890  
City, State, Zip: Phoenix, AZ 85082-2890

6. Total number of applications and patents involved: 1  
7. Total fee (37 C.F.R. 3.41)..... \$ 40.00  
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Total number of pages including cover sheet, attachments, and document: 3

OMB No. 0651-0011 (exp. 4/94)

04/13/2001 GTDN11 00000119 501086 09785750  
01 FC:581 40.00 CH

PATENT  
REEL: 011666 FRAME: 0913

## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, Frantisek Mikulenka of Roznov P/R Czech Republic, have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a corporation of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in BIAS STABILIZER CIRCUIT AND METHOD OF OPERATION (Attorney Docket No. ONS00173), described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by me, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

I hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and I further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

I agree that, when requested, I will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

I covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Frantisek Mikulenk

Frantisek Mikulenk

Date: 31.01.2001

Witnessed by: Antonin Rozsypal  
Signature

Date: 31.01.2001

ANTONIN ROZSYPAL  
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